


Cite this: *RSC Adv.*, 2022, 12, 4395

DFT-based study of the structural, optoelectronic, mechanical and magnetic properties of Ti_3AC_2 ($\text{A} = \text{P}, \text{As}, \text{Cd}$) for coating applications

R. M. Arif Khalil,^a Muhammad Iqbal Hussain,^{ID} *^{ab} Nadia Luqman,^a Fayyaz Hussain,^{*a} Anwar Manzoor Rana,^a Muhammad Saeed Akhtar^{*b} and Rana Farhat Mehmood^c

The first-principles approach has been used while employing the Perdew–Burke–Ernzerhof exchange–correlation functional of generalized gradient approximation (PBE–GGA) along with the Hubbard parameter to study the structural, optoelectronic, mechanical and magnetic properties of titanium-based MAX materials Ti_3AC_2 ($\text{A} = \text{P}, \text{As}, \text{Cd}$) for the first time. As there is no band gap found between the valence and conduction bands in the considered materials, these compounds belong to the conductor family of materials. A mechanical analysis carried out at pressures of 0 GPa to 20 GPa and the calculated elastic constants C_{ij} reveal the stability of these materials. Elastic parameters, *i.e.*, Young's, shear and bulk moduli, anisotropy factor and Poisson's ratio, have been investigated in the framework of the Voigt–Reuss–Hill approximation. The calculated values of relative stiffness are found to be greater than $\frac{1}{2}$ for Ti_3PC_2 and Ti_3AsC_2 , which indicates that these compounds are closer to typical ceramics, which possess low damage tolerance and fracture toughness. Optical parameters, *i.e.*, dielectric complex function, refractive index, extinction coefficient, absorption coefficient, loss function, conductivity and reflectivity, have also been investigated. These dynamically stable antiferromagnetic materials might have potential applications in advanced electronic and magnetic devices. Their high strength and significant hardness make these materials potential candidates as hard coatings.

Received 25th October 2021
Accepted 18th December 2021

DOI: 10.1039/d1ra07856a

rsc.li/rsc-advances

1. Introduction

Recently, MAX phases have captured the attention of a lot of researchers due to the discovery of MXenes,^{1–3} which are a novel 2D material made from transition metal carbides and nitrides. MXenes offer higher shielding effectiveness due to their moderate electrical conductivity and can be obtained by the selective etching of the A-layer from a MAX material.^{6,7} MXenes have the capability to provide perfect guidance to design shielding materials for electromagnetic interference,⁸ and can be used as an electrode material to enhance the capacitance of super-capacitors.⁹ The family of MAX materials exhibiting properties of metals and ceramics simultaneously was first reported in the early 1960s by Nowtony and co-workers. Later, in 1996, Barsoum *et al.* discovered a fascinating MAX material, titanium silicon carbide Ti_3SiC_2 .^{10–13} Titanium-based MAX materials like Ti_3SiC_2 , Ti_3AlC_2 and Ti_2AlC have demonstrated unique properties such as high temperature strength, low

density and good oxidation resistance.^{14,15} Moreover, lithium-based MAX materials like $\text{Li}_2\text{Ti}_3\text{O}_7$, LiNiO_2 , Li_xCoO_2 , and $\text{Li}_x\text{-TiO}_2$ have extraordinary technological applications.^{16,17}

MAX materials are denoted as $\text{M}_{n+1}\text{AX}_n$, where M represents a transition metal, A represents an element from groups XIII–XVI, X is either carbon or nitrogen and n may vary from 1–3.^{18,19} MAX compounds are categorized in distinct phases, namely, 211, 312 and 413, with respect to the value of n .²⁰ The foremost distinction among MAX alloys depends upon the number of inserting A layers per M layers.²¹ Mechanically, MAX compounds are different from MX carbides and nitrides.²² The incredible characteristics of MAX phases solely depend on M–X bonds with covalent–metallic nature, and are extremely strong when compared with M–A bonds.²³ Ti_3AlC_2 from the Ti–Al–C family is a very interesting MAX material due to its greatly tailorable properties.²⁴ Experimental and computational investigations to explore the properties of MAX phase materials have been reported. Various MAX materials like Ti_3SiC_2 , Zr_2AlC_2 , V_2AlC , $\text{V}_4\text{AlC}_{3-x}$, $\text{V}_{12}\text{Al}_3\text{C}_8$, $\text{Mo}_2\text{TiAlC}_2$, $\text{Mo}_2\text{Ti}_2\text{AlC}_3$, Ti_3AlC_2 , Ti_2InC , Zr_2InC and Hf_2InC have demonstrated unique and promising structural, mechanical, electrical and optical properties.^{25–31} MAX phases have great importance in shielding and coating applications, such as the *in situ* growth of MAX phase coatings on carbonised wood and their terahertz shielding properties,³² exfoliation and defect control of the two-

^aMaterials Simulation Research Laboratory (MSRL), Department of Physics, Bahauddin Zakariya University, Multan, 60800, Pakistan. E-mail: miqbal@ue.edu.pk; fayyazhussain248@yahoo.com

^bDepartment of Physics, University of Education, Lahore, 54000, Pakistan. E-mail: saeed.akhtar@ue.edu.pk

^cDepartment of Chemistry, University of Education, Lahore, 54000, Pakistan



dimensional few-layer MXene $\text{Ti}_3\text{C}_2\text{T}_x$ for electromagnetic interference shielding coatings,³³ highly conductive and scalable $\text{Ti}_3\text{C}_2\text{T}_x$ -coated fabrics for efficient electromagnetic interference shielding,³⁴ “beyond $\text{Ti}_3\text{C}_2\text{T}_x$: MXene for electromagnetic interference shielding”³⁵ and MAX phase-based electroconductive coating for high-temperature oxidizing environment.³⁶

As per the literature, there is no experimental or computational study reported till date on the novel Ti_3AC_2 ($A = \text{P, As, Cd}$) combination of titanium-based MAX materials. Since MAX phases have great importance in shielding and coating applications, as discussed above, this challenge has motivated us to computationally inspect the structural, optoelectronic, mechanical and magnetic properties of these compounds for the first time using an *ab initio* approach, where calculations have been performed using the CASTEP simulation code.

2. Computational methodology

The first-principles simulation was performed opting for the plane wave pseudo-potential based on DFT,³⁷ as employed in the CASTEP code.³⁸ The structural parameters were investigated by considering electron-ion interactions with a cut-off energy of 600 eV using norm conserving pseudo-potentials.^{39,40} A Monkhorst-Pack grid of $10 \times 10 \times 2$ was chosen to model the Brillouin zone (BZ).⁴¹ For settling down ionic positions, the conjugate gradient method was used.⁴² The structural parameters of the system in anticipation of Hellmann-Feynman forces were found to be significantly less than $0.02 \text{ eV } \text{\AA}^{-1}$ in an energy convergence criterion of $1 \times 10^{-5} \text{ eV}$.⁴³ The PBE-GGA functional in addition to the Hubbard parameter U was utilized, particularly to evaluate the electronic and magnetic properties of the system.^{44,45} The values of U for Ti and Cd atoms were opted as 2.5 eV and 2.0 eV, respectively. The U -values opted for these calculations are taken from the standard parameterization, as mentioned in the CASTEP code. Optical and mechanical properties were calculated under the umbrella of Kramer-Kronig relations^{46,47} and the Voigt-Reuss-Hill approximation.^{48,49} To determine the thermal stability of Ti_3AC_2 ($A = \text{P, As, Cd}$), phonon frequencies have been illustrated while utilizing density functional perturbation theory.⁵⁰

3. Results and discussions

3.1. Structural and electronic properties

The structural investigations revealed that Ti_3AC_2 ($A = \text{P, As, Cd}$) exhibited a hexagonal crystal structure with the point group (D_{6h} , $6/mmm$, $6/m \ 2/m \ 2/m$) and space group ($P6_3/mmc$, $P6c2c$). Interestingly, the structure of Ti_3AC_2 ($A = \text{P, As, Cd}$) is found to be similar to many MAX materials, such as Ti_3SiC_2 and Ti_3GeC_2 ,^{24,51} with its lattice parameters given in Table 1. The Wyckoff positions of Ti, A and C atoms are located at 2a, 2b and 4f, respectively, as shown in Fig. 1.

The search for geometric optimization and structural stability is the initial step in any first-principles simulation. For this reason, energy *versus* volume graphs for each Ti_3AC_2 ($A = \text{P, As, Cd}$) material are plotted in Fig. 2, and the data is fitted

Table 1 Calculated structural parameters for the Ti_3AC_2 ($A = \text{P, As, Cd}$) compounds

Material	a (Å)	c (Å)	c/a	V (Å ³)	E_0 (Ry)
Ti_3PC_2	3.149	16.798	5.33	144.284	−11 919.74
Ti_3AsC_2	3.149	16.798	5.33	144.284	−19 595.75
Ti_3CdC_2	3.167	18.906	5.969	164.276	−32 935.30

rendering to the rule of energy of state (EOS) owing to Birch-Murnaghan.⁵² The calculated formation energy of the considered Ti_3AC_2 ($A = \text{P, As, Cd}$) materials is negative, which indicates the structural stability of these MAX materials.⁵³ The negative ground state energy values for Ti_3AC_2 ($A = \text{P, As, Cd}$) at static equilibrium are found to be −11 919.74 Ry, −19 595.75 Ry and −32 935.30 Ry, respectively.

The band structures of Ti_3AC_2 ($A = \text{P, As, Cd}$) have been anticipated within the 1st Brillouin zone (BZ) along with high symmetry lines from the calculated structural parameters. Fig. 3 depicts the electronic band structures of Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 , and reveals the metallic behaviour of these compounds. As a matter of fact, no band gap has appeared across the Fermi level (E_F), and the electronic states of valence and conduction bands are overlapping. Such metallic behaviour of the Ti_3AC_2 compounds is quite analogous to a few already reported materials with MAX phases.^{54,55} Ti_3AC_2 ($A = \text{P, As, Cd}$)

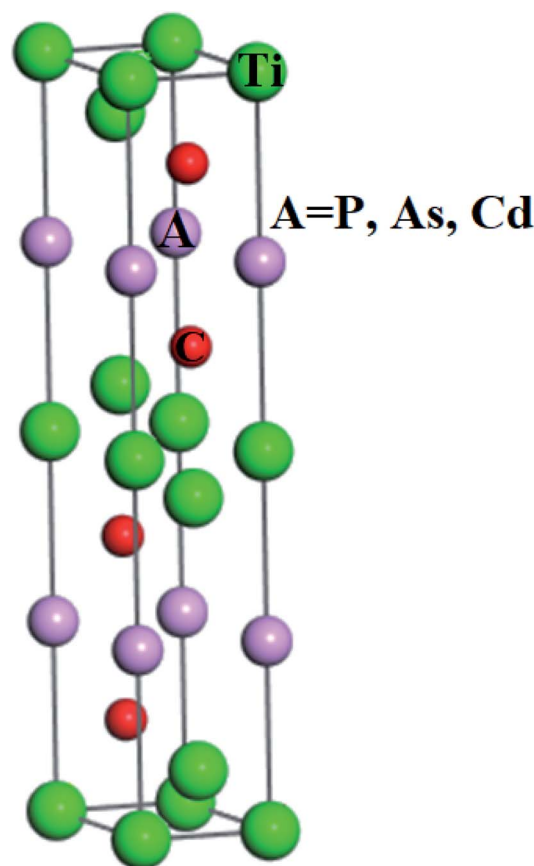


Fig. 1 The crystal structure of Ti_3AC_2 ($A = \text{P, As, Cd}$).



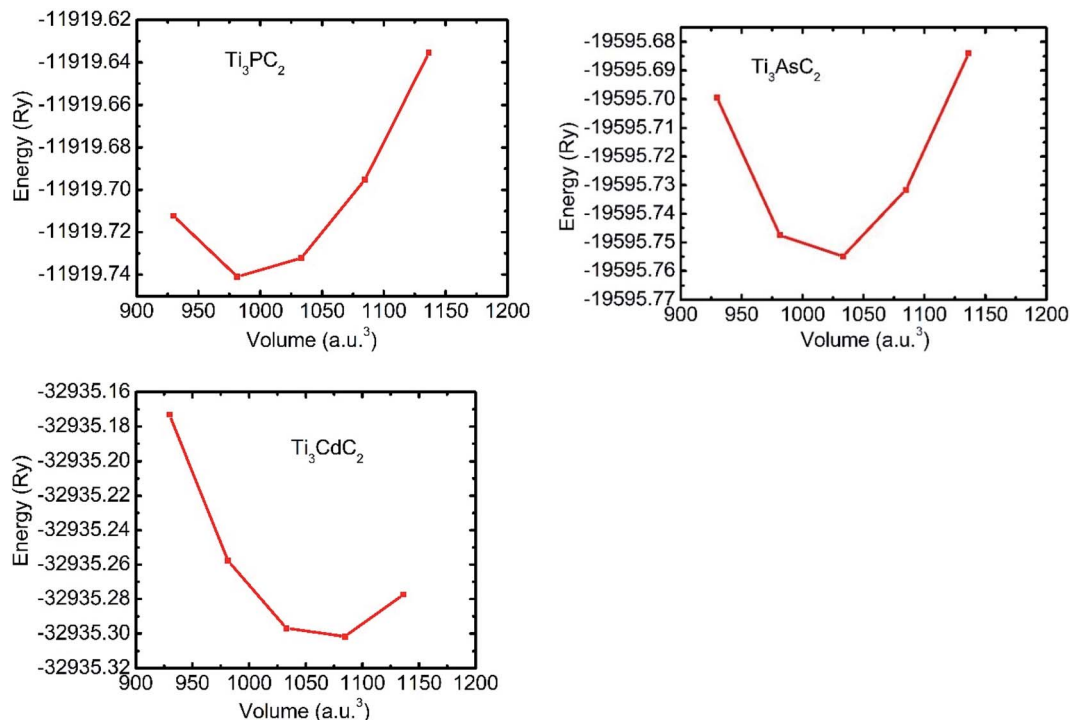


Fig. 2 Energy vs. volume optimization graphs of Ti₃PC₂, Ti₃AsC₂ and Ti₃CdC₂.

can offer excellent electrical, thermal and metallic conductivity. The total density of states (TDOS) of Ti₃PC₂, Ti₃AsC₂ and Ti₃CdC₂ determined at E_F revealed that these materials exhibit 5.87, 6.22 and 2.95 states per eV, respectively, as depicted in Fig. 4 along with the PDOS. Moreover, it has been observed that the value of TDOS for Ti₃AsC₂ is slightly greater than those of Ti₃PC₂ and Ti₃CdC₂, indicating the more conductive nature of this compound. The occupied valence states of Ti₃PC₂, Ti₃AsC₂ and Ti₃CdC₂ are observed to be at -6.13 , -6.00 and -8.35 eV, respectively, with respect to the E_F , as shown in Fig. 3.

Fig. 4(a) demonstrates the partial density of states (PDOS) for Ti₃PC₂. Hybridization in the valence band from -11.6 to -9.7 eV occurs due to the 3s states of P and 2s states of C. The hybridization between the 3d states of Ti, 3p states of P and C in the valence band from -4.2 to -2.0 eV resulted in raising the top of the valence band towards the E_F . As for the conduction band, the contribution of the 3d states of Ti near the E_F appears as a higher density of states in the region from 1.4 to 2.8 eV. Fig. 4(b) demonstrates the PDOS for Ti₃AsC₂. Hybridization of the s states of As and C appeared from -10.6 to 9.6 eV. The top of the valence band rises towards the E_F due to the mix p states of As, C and the d states of Ti in the valence band from -3.6 to -1.6 eV. The maximum density of states in the conduction band appears due to the 3d states of Ti from 1.9 to 2.7 eV. Fig. 4(c) shows that the hybridization in Ti₃CdC₂ resulted from the 2s states of C with the 3p and 3d states of Ti from -11.5 to -9.5 eV. The maximum density of states within the valence band appears due to the 3d states of Cd from -12.6 to -10.7 eV. The interaction between the s and p states of Ti and C from -7.9 to -5.8 eV raises the valence band towards the E_F . The strong

hybridization between the 3d states of Ti and 2p states of C from -4.2 to -2.4 eV is evidence for Ti–C covalent bonds in Ti₃CdC₂. The maximum density of states in the conduction band from 1.5 to 2.4 eV appeared due to the 3d states of Ti.⁵⁶

3.2. Optical and dynamical properties

3.2.1 Optical properties. It is well known that optical properties of materials have strong correlations with their electronic band structure.⁵⁶ The optical properties of the Ti₃AC₂ (A = P, As, Cd) compounds were calculated with a Gaussian smearing of 0.5 eV and variation in energy from 0 to 20 eV. The interaction of electromagnetic (EM) radiation is supposed to be plane polarized along $[1\ 0\ 0]$ with the material and the optical parameters, *i.e.*, refractive index, extinction coefficient, absorption, loss function, optical conductivity and reflectivity, have thus been investigated.⁵⁷

3.2.1.1 Complex dielectric function. The complex dielectric constant is an energy dependent function that has major contributions towards the optical properties of materials. It has real ($\epsilon_1(\omega)$) and imaginary parts ($\epsilon_2(\omega)$) that provide information regarding the polarization/dispersion and absorption of light, respectively, in relation to the electronic band structure of materials. In Fig. 5(a), behaviour of the real part of the dielectric constant is depicted as a function of energy with static values of 182, 242 and 72 for Ti₃PC₂, Ti₃AsC₂ and Ti₃CdC₂, respectively. For all compounds, the real part of the dielectric function extends towards negative values for higher energies, showing the metallic behaviour of the compounds. Fig. 5(b) shows the behaviour of the imaginary part of the dielectric function for Ti₃PC₂, Ti₃AsC₂ and Ti₃CdC₂ with static values of 57, 76 and 12



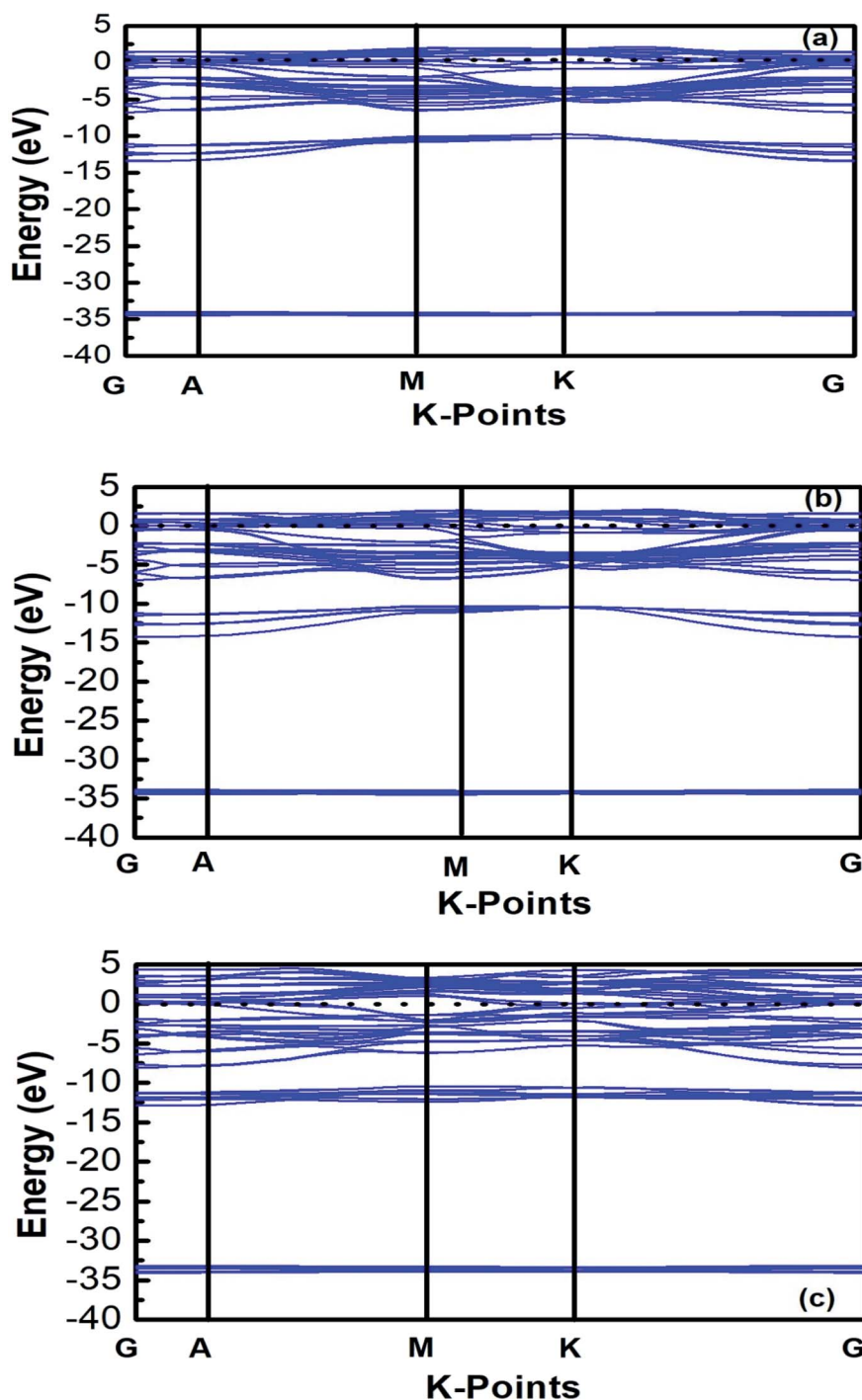


Fig. 3 Band structures of (a) Ti_3PC_2 , (b) Ti_3AsC_2 and (c) Ti_3CdC_2 .

at 0 eV, respectively. The imaginary part also demonstrated the metallic behaviour of the MAX compounds.

3.2.1.2 Refractive index and extinction coefficient. The refractive index represents the phase velocity and the extinction coefficient describes the absorption losses when EM radiation passes through the material. Fig. 6(a) shows the variation in refractive index for Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 as a function of photon energies. It has been observed that Ti_3AsC_2 demonstrates the maximum value of refractive index among the

studied compounds due to considerable interaction between the valence electrons and incident photons. This interaction ultimately resulted in polarization within the material.⁵⁸

Fig. 6(b) represents the static values of the extinction coefficient calculated for Ti_3CdC_2 , Ti_3PC_2 and Ti_3AsC_2 , which are found to be 0.7, 2 and 2.4, respectively. Ti_3PC_2 shows two strong peaks at 0.5 and 2.2 eV, Ti_3AsC_2 only shows a single peak at 0.7 eV, and Ti_3CdC_2 shows two peaks at 1.2 and 2.9 eV. The extinction coefficients for the three considered materials follow



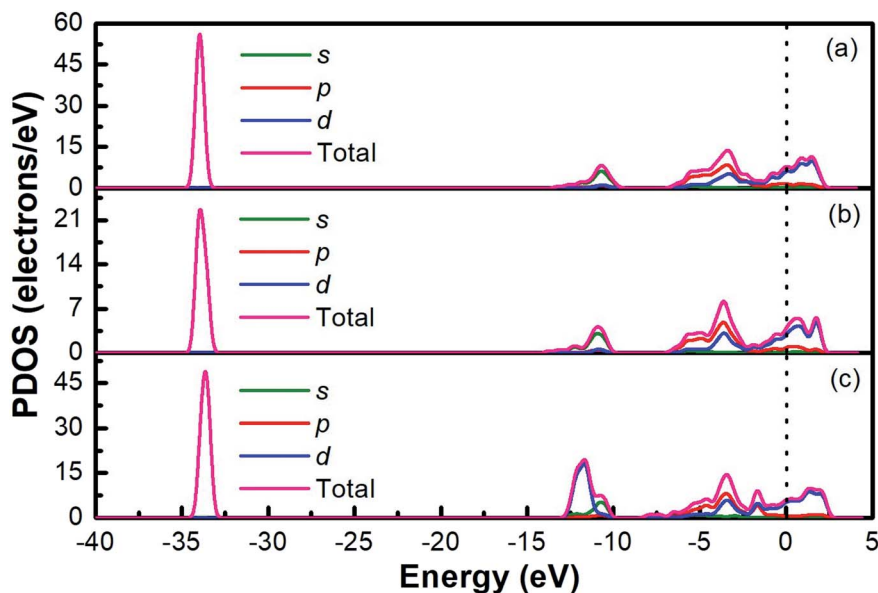


Fig. 4 Partial density of states of (a) Ti_3PC_2 , (b) Ti_3AsC_2 and (c) Ti_3CdC_2 .

a decreasing trend for energies ranging from 5 to 20 eV. Among these three materials, the values of the extinction coefficients allude to the fact that Ti_3AsC_2 absorbs more radiation as compared to Ti_3PC_2 and Ti_3CdC_2 .

3.2.1.3 Absorption coefficient and energy loss function. It is well known that the absorption coefficient of any material dictates the amount of photon energy absorbed. Instead of absorption, the extinction coefficient helps to estimate the conversion efficiency of many optical materials for applications in solar devices.⁵⁹ The absorption spectra of Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 , as shown in Fig. 7(a), reveal the metallic behaviour of the compounds due to the absorption of incident photons of all energies. A sharp increasing trend in the absorption coefficient has been observed from almost 5 eV, and at energies about 14 eV, it decreases drastically. Ti_3AsC_2 exhibits maximum absorption as a result of transitions from the p state of As and the 3d state of Ti⁶⁰ when compared with Ti_3PC_2 and Ti_3CdC_2 . The sudden drop of absorption above 13 eV might lead to plasma resonance.

The loss function describes the plasma resonance frequencies that appear due to effects like dispersion, heating and scattering. At plasma frequencies, the loss function demonstrates its maximum value. Fig. 7(b) shows the loss functions and bulk plasma frequencies for Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 to be 7.8 (13.3 eV), 29 (15.7 eV) and 7.3 (14.3 eV), respectively. At higher frequencies, the loss function for Ti_3CdC_2 attains its minimum value; hence, this compound could be a suitable dielectric material. If the plasma frequencies are slightly lower than that of the incident photons, the compounds are considered transparent.⁵⁹

3.2.1.4 Optical conductivity and reflectivity. Optical conductivity describes the conductivity of EM radiation with a threshold frequency through the material's surface by inter- and intra-band transitions. It approximately follows a similar trend as that for the absorption spectra of MAX materials. Fig. 8(a) depicts the optical conductivity of the Ti_3AC_2 (A = P, As, Cd). The optical conductivity fluctuates between 0.2 to 7.0 eV, and attains its maximum value, *i.e.*, 2.1, 2.4 and 2.7 eV for

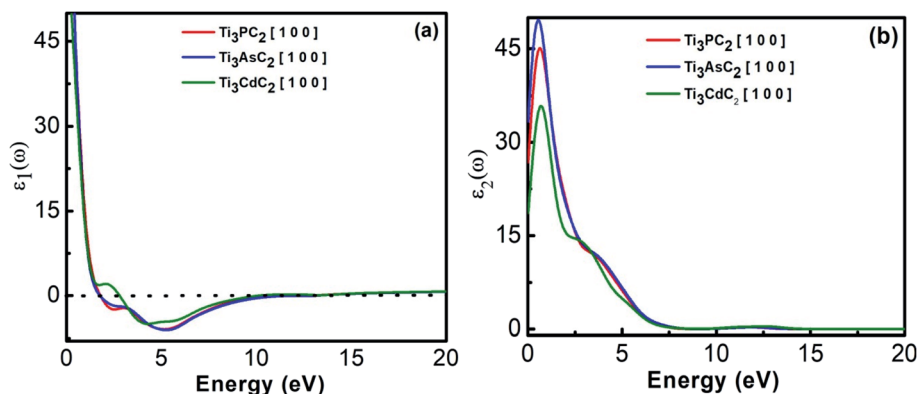


Fig. 5 (a) Real dielectric function and (b) imaginary dielectric function of Ti_3AC_2 (A = P, As, Cd).



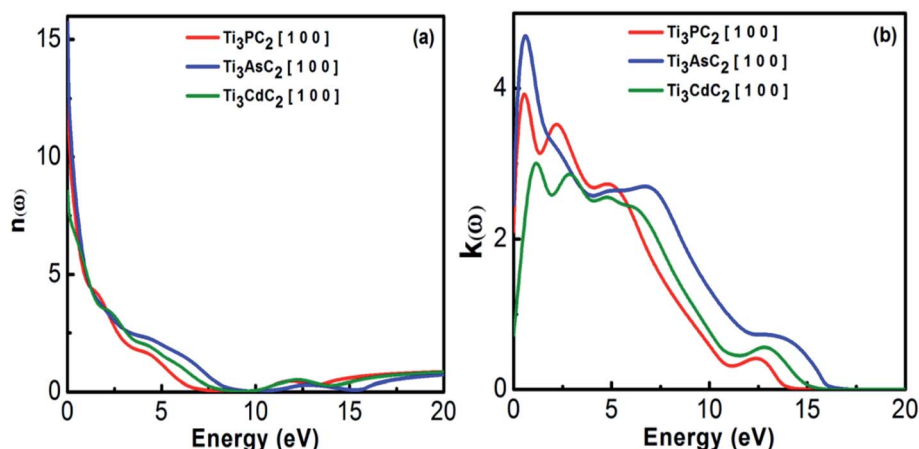


Fig. 6 (a) Refractive index and (b) extinction coefficient of Ti_3AC_2 ($A = \text{P, As, Cd}$).

Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 , respectively, followed by a sharp decrease and a dip between 9 and 10 eV.

Reflectivity helps to explain the surface behavior of MAX materials. Reflectivity is a ratio of the energy possessed by incident photons to that of reflected photons. Maximum reflectivity is observed specifically in the UV and in the moderate IR regions. In the visible region, the considered MAX materials offer 44% reflectivity and are potential candidates to reduce solar heating.⁵⁴ The static values of reflectivity for Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 are found to be 0.75, 0.78 and 0.63, respectively, at an incident energy of 0 eV, as shown in Fig. 8(b). A sharp increasing trend in reflectivity towards its corresponding maximum values at 8.9 eV (0.99), 10 eV (0.99), and 9.2 eV (0.94) has been observed. Afterwards, sharp and spiky dips appeared around 12 eV followed by further enhancement in the reflectivity values.

3.2.2 Dynamical properties. It is worth mentioning that neither theoretical nor experimental efforts have been made so far to explore the dynamical properties of these materials. Therefore, at present, a comparative study of the observed

results with the literature is not possible. However, the outcomes pertaining to calculated phonon frequencies could be beneficial for determining the dynamical and thermodynamical properties of these MAX phases experimentally.

As there are 12 atoms in Ti_3AC_2 ($A = \text{P, As, Cd}$), resulting in 36 phonon branches or modes of vibration, three modes at zero frequency are recognized as acoustic modes and the remaining 33 modes are called optical modes of vibration. From these 33 optical modes of vibration, 12 modes are found to be Raman active, 9 modes are IR active and 12 calculated modes are found to be inactive modes. Our calculated total modes for the Ti_3AC_2 ($A = \text{P, As, Cd}$) phases are consistent with a previous theoretical study of the lattice dynamics of Al-containing carbides M_3AlC_2 ($M = \text{Ti, V, Ta}$).⁶¹ However, a select 7 (out of 12) Raman and 6 (out of 9) IR active modes for each phase are given in Table 2, and the remaining Raman and IR active modes can be called degenerate modes, as mentioned above. These compounds are found to be dynamically stable because no imaginary frequency or soft mode^{51,57} appears at the gamma (Γ) point. The calculated symmetries and phonon frequencies for the considered

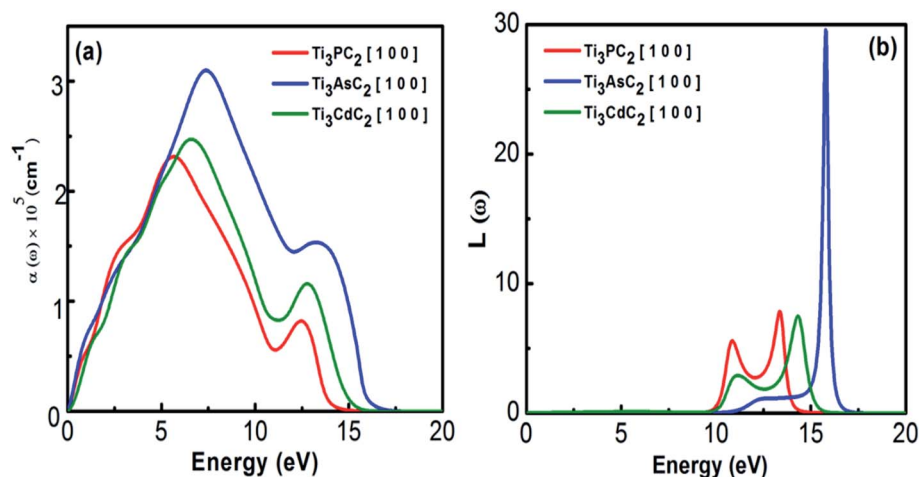


Fig. 7 (a) Absorption coefficient and (b) energy loss function of Ti_3AC_2 ($A = \text{P, As, Cd}$).



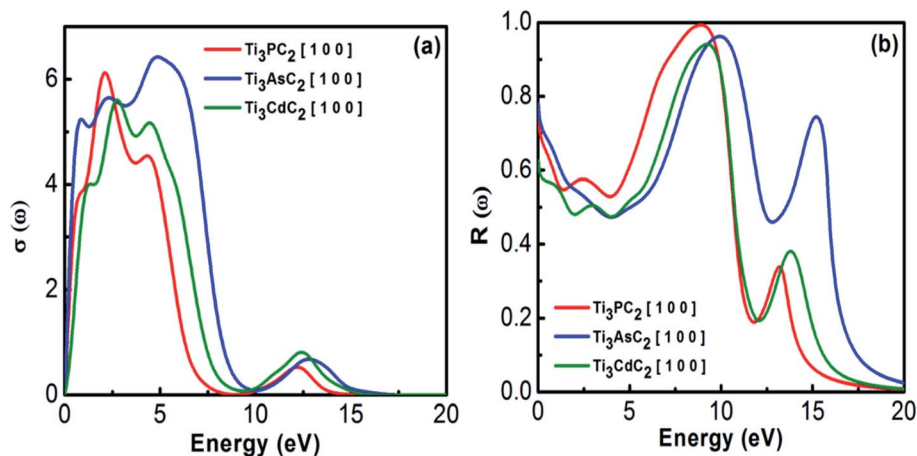


Fig. 8 (a) Optical conductivity and (b) reflectivity of Ti_3AC_2 (A = P, As, Cd).

compounds, *i.e.*, Ti_3AC_2 (A = P, As, Cd), are listed in Table 2. For these compounds, the modes of vibration are categorized by irreducible representations⁶² of the point group symmetry $D_{6h}/6/mmm$ and the space group symmetry $P6_3/mmc$ in the hexagonal phase of the crystal structure. The highest frequencies of the Raman modes are observed at 621, 656 and 644 cm^{-1} , while the highest IR modes are observed at 542, 569 and 603 cm^{-1} for Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 , respectively. The modes in the range of frequency between 175 cm^{-1} to 546 cm^{-1} are due to the similar motion of Ti and C atoms in all the structures. The highest frequency modes are due to the motion of carbon atoms. The low frequency Raman modes around 98 cm^{-1} are due to the motion of the heavy atoms Ti and As in the Ti_3PC_2

and Ti_3AsC_2 phases, respectively. However, the low frequency Raman modes at 55 cm^{-1} are due to the motion of the Cd atom in the Ti_3CdC_2 system.

3.3. Mechanical properties

After experiencing external stress, a material's response may correspond to its elastic properties, *i.e.*, bond strength and mechanical stability. The mechanical properties of Ti_3AC_2 (A = P, As, Cd) at various pressure values, *i.e.*, 0 GPa, 5 GPa and 10 GPa, are listed in Tables 3 and 4. Shear deformation can illustrate the ductility of a material.⁶³ Hooke's law, fitted to shapeless crystals, has been used in the framework of the robust CASTEP simulation code along with the stress-strain behavior in order to calculate the elastic parameters. As reported, the strain pattern of the materials can be reduced significantly for crystals with a low symmetry having mutually independent elastic constants.⁶⁴

The elastic constants of the considered MAX materials satisfy Born's criterion⁵⁷ with positive values, leading to the assessment that these materials are mechanically stable. The anisotropy factor for the hexagonal phase of MAX materials is defined as $K_c/K_a = (C_{11} + C_{12} - 2C_{13})/(C_{33} - C_{13})$, where K_c and K_a are the compressibility coefficients along the *c*- and *a*-axes, respectively. Bulk and shear moduli are used to determine the hardness,⁶⁵ whereas Young's modulus is used to estimate the stiffness of

Table 2 Phonon frequencies (cm^{-1}) of Ti_3AC_2 (A = P, As, Cd) calculated at the Γ point

Compounds	Raman	Irreducible representation	IR	Irreducible representation
Ti_3PC_2	97.954	E_{2g}	224.587	E_{1u}
	175.920	E_{1g}	281.274	E_{1u}
	257.668	A_{1g}	327.291	A_{2u}
	282.717	E_{2g}	427.818	A_{2u}
	549.843	E_{2g}	505.430	A_{2u}
	557.923	E_{1g}	542.772	E_{1u}
	621.215	A_{1g}	—	—
Ti_3AsC_2	97.666	E_{2g}	165.367	E_{1u}
	195.099	E_{1g}	254.128	A_{2u}
	210.859	E_{2g}	264.557	E_{1u}
	292.288	A_{1g}	387.196	A_{2u}
	586.373	E_{2g}	545.675	A_{2u}
	590.789	E_{1g}	569.994	E_{1u}
	656.223	A_{1g}	—	—
Ti_3CdC_2	54.925	E_{2g}	82.951	E_{1u}
	172.088	E_{1g}	133.859	A_{2u}
	175.877	E_{2g}	279.249	E_{1u}
	244.316	A_{1g}	357.470	A_{2u}
	598.555	E_{1g}	540.045	A_{2u}
	599.4584	E_{2g}	603.724	E_{1u}
	644.810	A_{1g}	—	—

Table 3 Elastic constants C_{ij} of Ti_3AC_2 (A = P, As, Cd)

Compounds	Pressure (GPa)	C_{11}	C_{12}	C_{13}	C_{33}	C_{44}
Ti_3PC_2	0	318	237	58	382	197
	5	335	105	63	365	118
	10	297	95	111	348	184
Ti_3AsC_2	0	340	62	79	368	146
	5	343	67	84	367	148
	10	347	71	80	376	147
Ti_3CdC_2	0	354	135	211	265	140
	5	355	135	202	263	137
	10	392	125	240	256	176



Table 4 Young's, bulk and shear moduli, Pugh's ratio, machinability index, Poisson's ratio, shear anisotropic factor, and linear compressibility coefficients of Ti_3AC_2 ($A = \text{P, As, Cd}$)

Compounds	E (GPa)	B (GPa)	G (GPa)	G/B	B/G	B/C_{44} (GPa)	ν	A	α
Ti_3PC_2	275	157	114	0.7	1.37	0.79	0.2	1.3	1.3
	282	155	118	0.8	1.31	0.82	0.2	0.8	1.0
	286	151	121	0.8	1.27	0.82	0.2	1.7	0.1
Ti_3AsC_2	326	162	140	0.9	1.16	1.10	0.2	1.1	0.8
	327	166	140	0.8	1.19	1.12	0.2	1.1	0.8
	327	166	141	0.9	1.18	1.12	0.2	1.1	0.9
Ti_3CdC_2	206	217	77	0.4	2.82	1.55	0.3	2.8	1.2
	184	211	68	0.3	3.10	1.54	0.3	2.5	1.4
	186	229	68	0.2	4.40	1.30	0.4	4.1	2.5

solid materials.⁵⁶ The elastic constants of the considered MAX materials reveal their anisotropic nature. Table 4 summarizes the mechanical properties of the MAX materials using the Voigt–Reuss–Hill approximation.^{66–68}

The Young's (E), bulk (B) and shear (G) moduli can be expressed as follows:

$$E = \frac{9BG}{3B + G} \quad (1)$$

where

$$B = \frac{B_V + B_R}{2} \quad (2)$$

and

$$G = \frac{G_V + G_R}{2} \quad (3)$$

The values of Young's modulus follow the trend of $\text{Ti}_3\text{AsC}_2 > \text{Ti}_3\text{PC}_2 > \text{Ti}_3\text{CdC}_2$, revealing that Ti_3AsC_2 is a bit stiffer than the Ti_3PC_2 and Ti_3CdC_2 compounds. The values of the bulk modulus follow the trend of $\text{Ti}_3\text{CdC}_2 > \text{Ti}_3\text{AsC}_2 > \text{Ti}_3\text{PC}_2$. The calculated value for shear modulus follows the order of $\text{Ti}_3\text{AsC}_2 > \text{Ti}_3\text{PC}_2 > \text{Ti}_3\text{CdC}_2$. In solids, Pugh's ratios B/G and G/B decide the brittle or ductile nature of materials. If $B/G > 1.75$ and $B/G < 0.5$, then the material is considered ductile; otherwise, it is brittle.^{52,58} According to Pugh's criteria, Ti_3PC_2 and Ti_3AsC_2 possess a brittle nature, while Ti_3CdC_2 is found to be a ductile material. The value of the machinability index^{69,70} follows the order of $\text{Ti}_3\text{CdC}_2 > \text{Ti}_3\text{AsC}_2 > \text{Ti}_3\text{PC}_2$.

Poisson's ratio ν , the shear anisotropy factor A and the linear compressibility coefficient can be calculated using the expressions given below:

$$\nu = \frac{1}{2} \left[\frac{B - \frac{2}{3}G}{B + \frac{1}{3}G} \right] \quad (4)$$

$$A = \frac{4C_{44}}{(C_{11} + C_{33} - 2C_{13})} \quad (5)$$

$$\alpha = \frac{K_c}{K_a} = \frac{C_{11} + C_{12} - C_{13}}{C_{33} - C_{13}} \quad (6)$$

Poisson's ratio determines the degree of covalent bonding in materials.⁵¹ It has a value of 0.25 for ionic materials and 0.1 for covalent materials. Table 4 shows that Poisson's ratios for the studied MAX materials are around 0.25; therefore, the materials exhibit ionic character. The anisotropy factor helps to understand the isotropic or anisotropic nature of materials. If its value is 1, then the material is considered isotropic; otherwise, it is an anisotropic material.⁵¹ In the current study, the MAX materials are observed to be anisotropic, and might have potential applications in crystal physics and engineering sciences.⁷¹ Table 4 reveals that the considered MAX materials exhibit large linear compressibility (α) along the a -axis instead of along the c -axis.⁵¹

3.3.1 Bond stiffness. Generally, Pugh's ratio is not considered a good indicator for MAX phase materials when it comes to exhibiting their high damage tolerance and fracture toughness experimentally. Thus, the computational mode of bond stiffness can well predict the damage tolerance of these MAX phases using the ratio of bond stiffness of the weakest and strongest bonds. This criterion is also applied nowadays to ternary-layered borides such as MoAlB .^{72,73} In MAX phases, chemical bonding involves the incorporation of ionic, covalent and metallic bonding, wherein bonding between M–X slabs is deemed stronger than bonding among the M–A slabs.^{22,72} Thus, bond stiffness of the M–A slabs decreases with the increase of that of the M–X slabs in MAX phases.⁷³

Furthermore, according to mechanics, for a classical spring, a relation between load and deformation is defined by Hooke's law.⁷³ It is assumed here that a similar relation exists for chemical bonds in a solid, and so bond stiffness can be utilized to characterize and quantify bond strength. Specifically, the bond length d as a function of pressure P can be estimated using lattice parameters and internal coordinates. As variation in P causes changes in the bond strength, the relative bond lengths (d/d_0), where d_0 denotes the bond length at 0 GPa, should be linked to P by a quadratic curve⁷⁴ obeying eqn (7), shown below. The slope of such a curve is defined as $1/k$, where k represents the bond stiffness.⁷³

$$d/d_0 = C_0 + C_1P + C_2P^2 \quad (7)$$



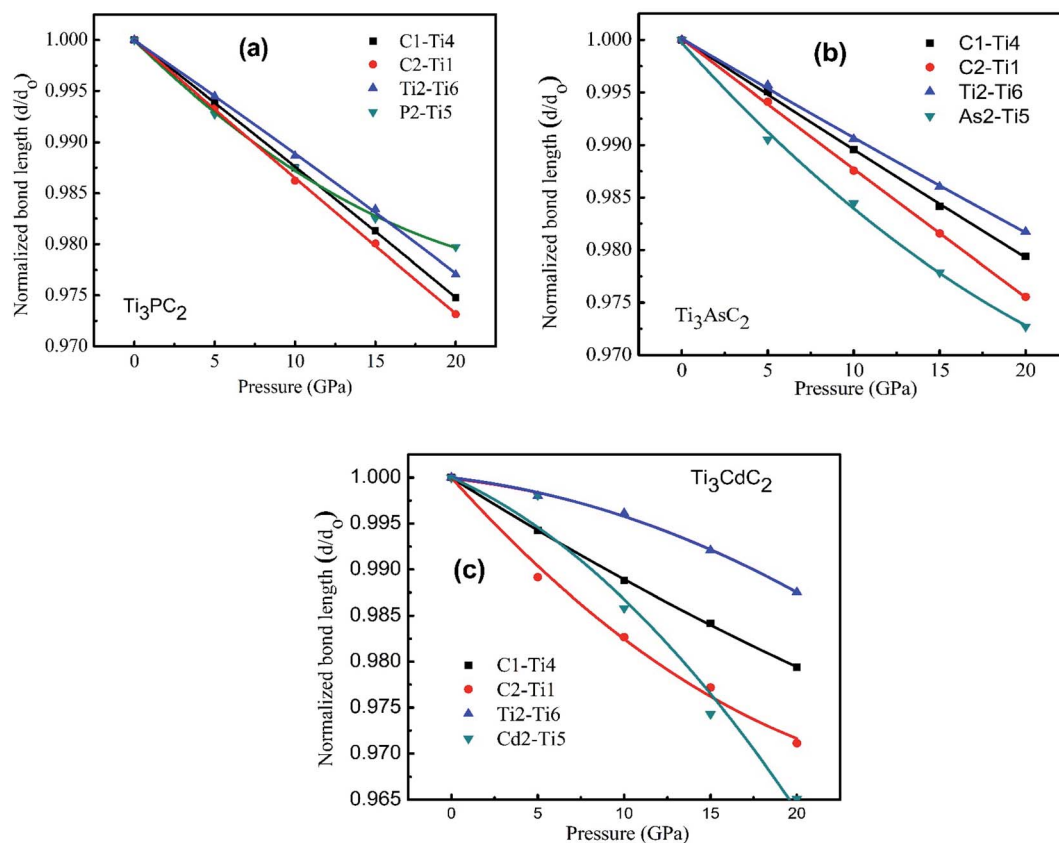


Fig. 9 Normalized bond length as a function of the external pressure from 0 to 20 GPa for (a) Ti_3PC_2 , (b) Ti_3AsC_2 and (c) Ti_3CdC_2 .

$$k = \left| \frac{d(d/d_0)}{dP} \right|^{-1} = |C_1 + 2C_2P|^{-1} \quad (8)$$

where C_i ($i = 0, 1, 2$) is the quadratic fitting coefficient.

Fig. 9(a)–(c) displays the behavior of normalized bond lengths calculated for Ti_3AC_2 ($A = \text{P, As, Cd}$) as a function of pressure from 0 GPa to 20 GPa. The declining patterns of all bonds on increasing pressure fortify our general viewpoint that

bond strength increases if pressure grows systematically. Table 5 presents the various bond lengths of the considered materials, *i.e.*, Ti_3AC_2 ($A = \text{P, As, Cd}$), calculated at a diverse range of pressures, ranging from 0 GPa to 20 GPa. As expected, the variation of bond strength in the Ti_3AC_2 ($A = \text{P, As, Cd}$) compounds follows the universal change of electronic configuration due to the increase of the atomic radii of the A elements, *i.e.*, $\text{P} \rightarrow \text{Cd}$. The results reveal that the bond length decreases with increasing pressure. In addition to this, C–Ti bonds are

Table 5 Bond lengths and bond population of Ti_3AC_2 ($A = \text{P, As, Cd}$)

Composite	Bonds	Bond length (Å)				
		0 GPa	5 GPa	10 GPa	15 GPa	20 GPa
Ti_3PC_2	C1–Ti4	2.10523	2.09254	2.07887	2.06590	2.05216
	C2–Ti1	2.18472	2.17020	2.15462	2.14117	2.12606
	P2–Ti5	2.48509	2.46707	2.45412	2.44168	2.43469
	Ti2–Ti6	2.95598	2.93971	2.92247	2.90698	2.88810
	Ti1–Ti5	2.95598	2.93971	2.92247	2.90698	2.88810
Ti_3AsC_2	C4–Ti5	2.08396	2.07373	2.06221	2.05094	2.04105
	C3–Ti2	2.17351	2.16077	2.14650	2.13346	2.12038
	Ti5–As2	2.56021	2.53600	2.52040	2.50360	2.49036
	Ti2–Ti6	2.92168	2.90907	2.89415	2.88085	2.86834
	C4–Ti5	2.05013	2.03233	2.02117	2.01164	2.00185
Ti_3CdC_2	C2–Ti1	2.17539	2.15182	2.13769	2.12577	2.11256
	Ti1–Ti5	2.89483	2.89334	2.88362	2.87191	2.85867
	Ti4–Cd2	2.97993	2.97423	2.93767	2.90332	2.87595
	Ti6–Cd1	2.97993	2.97423	2.93767	2.90332	2.87595
	Ti3–Cd1	2.97993	2.97423	2.93767	2.90332	2.87595

Table 6 Coefficients (C_1 , C_2) of the second order polynomial fit of relative bond length as a function of pressure and bond stiffness (k) for Ti_3AC_2 ($A = \text{P, As, Cd}$)

Composite	Bonds	$C_1 \times 10^{-3}$	$C_2 \times 10^{-5}$	k (GPa)	Relative stiffness
Ti_3PC_2	C1-Ti4	-1.220	-0.190	820	0.88
	C2-Ti1	-1.360	0.124	735	0.79
	Ti2-Ti6	-1.070	-0.335	935	1.00
	P2-Ti5	-1.530	2.590	654	0.70
	C1-Ti4	-1.070	0.128	935	0.90
Ti_3AsC_2	C2-Ti1	-1.240	0.072	806	0.77
	Ti2-Ti6	-0.959	0.178	1043	1.00
	As2-Ti5	-1.810	2.310	552	0.53
	C1-Ti4	-1.180	0.774	847	0.19
	C2-Ti1	-2.090	3.350	478	0.11
Ti_3CdC_2	Ti2-Ti6	-0.221	-2.010	4525	1.00
	Cd2-Ti5	-0.838	-4.850	1193	0.26

found to be stiffer than P-Ti bonds, while P-Ti bonds are stronger than As-Ti and Cd-Ti bonds in the Ti_3AC_2 ($A = \text{P, As, Cd}$) family. Since shorter bond lengths lead to strong bonding, the M-C slabs possess stronger bonds as compared to bonds in the M-A slabs. It should be noted that at 0 GPa, the C1-Ti4 bond (2.10523 Å) is 3.2% shorter than its counter bond C2-Ti1 (2.18472 Å) in Ti_3PC_2 . This implies that the C1-Ti4 bond is stronger. Similar analyses on the A elements ($A = \text{P, As, Cd}$) reflect that the P1-Ti6 bond (2.48509 Å) is 3.0% and 19.9% shorter than the As1-Ti3 (2.56021 Å) and Cd1-Ti6 bonds (2.97993 Å), respectively, indicating that the P1-Ti6 bond is comparatively stronger than its counterparts, *i.e.*, As1-Ti3 and

Cd1-Ti6. Table 6 discloses that the P2-Ti5 bond possesses a larger magnitude of bond stiffness, *i.e.*, 654 GPa, compared to that of the As2-Ti5 bond (552 GPa) but less than the bond stiffness calculated for Cd2-Ti5 (1193 GPa). Moreover, Table 6 lists the coefficients of the second order polynomial fit of relative bond lengths as a function of pressure for Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 . Here it is noteworthy that the negative magnitudes of coefficient C_1 and positive magnitudes for C_2 reveal an increase in the deformation resistance to compression with increasing pressure. This result is obvious from Fig. 9, which illustrates the decreasing trend of bond length. However, some negative values of coefficient C_2 demonstrate that an increase in

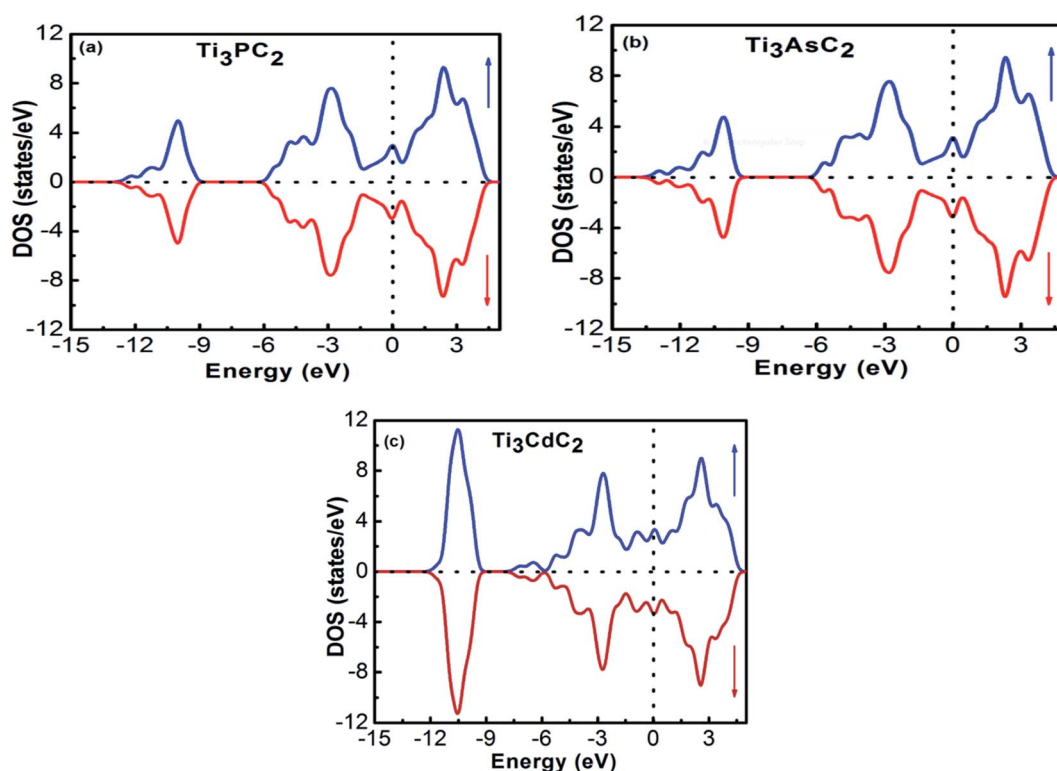


Fig. 10 Spin-polarized DOS of (a) Ti_3PC_2 , (b) Ti_3AsC_2 and (c) Ti_3CdC_2 .



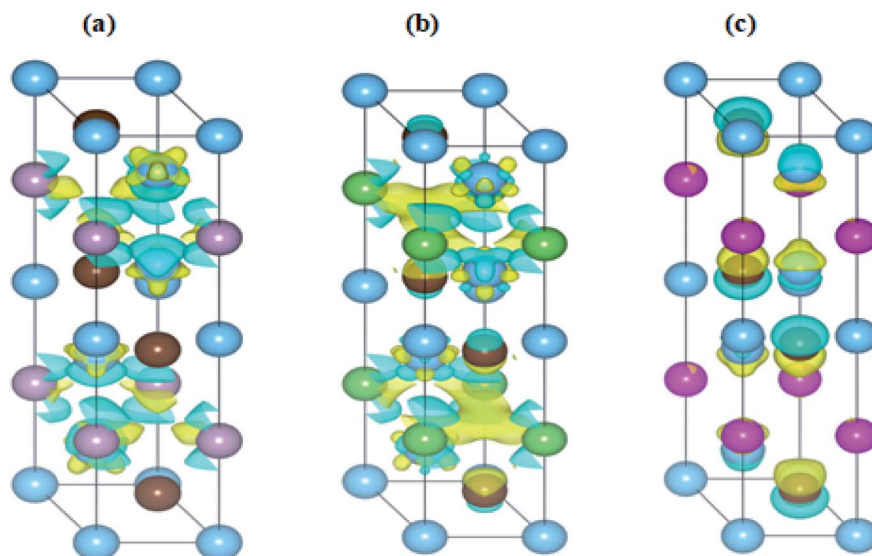


Fig. 11 Iso-surface charge density calculations of (a) Ti_3PC_2 , (b) Ti_3AsC_2 and (c) Ti_3CdC_2 .

the deformation resistance to compression with increasing pressure is relatively slow, as noticed particularly for the Ti2–Ti6 bond. In addition, it can be noticed that the relative stiffness (*i.e.*, the ratio of the bond stiffness of the weakest bond to that of the strongest bond) is greater than $\frac{1}{2}$ for Ti_3PC_2 and Ti_3AsC_2 but lower than $\frac{1}{2}$ for the Ti_3CdC_2 compound (Table 6). This means that Ti_3PC_2 and Ti_3AsC_2 are closer to typical ceramics, which possess low damage tolerance and fracture toughness.^{72,75} However, in the case of the Ti_3CdC_2 compound, a few unusual properties might be expected, such as its unusual stiffness of 4526 GPa for the Ti2–Ti6 bond.

3.4. Magnetic properties

The interaction of the constituent elements of a solid and the crystal fields produces significant effects, which are duly recognized as magnetism.⁷⁶ To account for these effects in the considered MAX compounds, the DFT + U functional was implemented. Regarding this, the spin-polarized DOS of Ti_3PC_2 , Ti_3AsC_2 and Ti_3CdC_2 were estimated and are shown in Fig. 10(a)–(c). The Fermi level was adjusted at 0 eV. It is observed that the spin up \uparrow states are exact replicas of the spin down \downarrow states in each studied compound, assuring the antiferromagnetic behavior of these materials. Moreover, due to such a symmetric behavior of the spin up \uparrow and spin down \downarrow states, the net magnetic moment for all compounds is observed to be zero. The existence of few states at the E_F further endorses the metallic nature of the compounds. It is important to mention here that prior to this study, neither theoretical nor experimental observations regarding the magnetic properties of these materials have been reported.

In Fig. 11(a)–(c), the charge difference calculation (isosurface charge density) plots clearly demonstrate the charge accumulation (yellow color) and charge depletion (cyan color). It has also been noticed from the charge density plots that most of the charge is either accumulated or depleted in between the inter-layers and on the Ti atoms in the case of the Ti_3PC_2 and Ti_3AsC_2

composites, while in the case of Ti_3CdC_2 , an inadequate amount of charge is accumulated and depleted on the C atoms. These results illustrate the antiferromagnetic behavior of the studied compounds.

4. Conclusions

In the present article, a DFT-based first-principles study has been carried out to investigate the structural, optoelectronic, mechanical and magnetic properties of Ti_3AC_2 (A = P, As, Cd). As no significant band gap exists between the valence and conduction bands, this fact depicts that the considered materials behave like conductors. The presence of DOS around the E_F describes the contribution of Ti 3d states to the conduction mechanism. The results pertaining to the elastic behavior indicated that these materials are not only thermally stable but mechanically stable as well. As per the data from Pugh's ratio, Ti_3PC_2 and Ti_3AsC_2 demonstrate a brittle nature, while Ti_3CdC_2 is ductile in nature. The values of relative stiffness greater than $\frac{1}{2}$ reveal that Ti_3PC_2 and Ti_3AsC_2 are closer to typical ceramics, which possess low damage tolerance and fracture toughness. The magnitude of reflectivity reveals that these materials can be potential candidates for coating various devices to prevent solar heating. Moreover, the studied materials are dynamically stable and exhibit antiferromagnetic behavior. Henceforth, these MAX materials with hexagonal phases would be very appropriate potential candidates for coating applications.

Conflicts of interest

There are no conflicts to declare.

References

- 1 Y. Gogotsi and B. Anasori, *J. Am. Ceram. Soc.*, 2019, **13**, 8491–8494.



- 2 M. Ghidui, S. Kota, V. Drozd and M. W. Barsoum, *Sci. Adv.*, 2018, **4**(1), 2–7.
- 3 F. Shahzad, M. Alhabeb, C. B. Hatter, B. Anasori, S. M. Hong, C. M. Koo and Y. Gogotsi, *Suppl. Mater.*, 2016, **353**(6304), 1137–1140.
- 4 L. Zhang, W. Sua, H. Shub, T. Lü, L. Fua, K. Song, X. Huang, J. Yud, C. T. Lind and Y. Tange, *Ceram. Int.*, 2019, **45**, 11468–11474.
- 5 M. Khazaeia, A. Mishrab, N. S. Venkataramananc, A. K. Singhb and S. Yunokia, *Curr. Opin. Solid State Mater. Sci.*, 2019, **23**, 164–178.
- 6 G. Rehman, S. A. Khan, R. Ali, I. Ahmad, L. Y. Gan and B. Amin, *J. Appl. Phys.*, 2019, **126**, 143101–143110.
- 7 J. Li, X. Li and B. V. D. Bruggen, *Environ. Sci.: Nano*, 2020, **7**, 1–16.
- 8 A. Iqbal, F. Shahzad, K. Hantanasirisaku, M. K. Kim, J. Kwon, J. Hong, H. Kim, D. Kim, Y. Gogotsi and C. M. Koo, *Science*, 2020, **369**, 446–450.
- 9 X. Zang, J. Wang, Y. Qin, T. Wang, C. He, Q. Shao, H. Zhu and N. Cao, *Nano-Micro Lett.*, 2020, **12**, 1–24.
- 10 M. W. Barsoum, *Prog. Solid State Chem.*, 2000, **28**, 201–281.
- 11 P. Finkel, M. W. Barsoum and T. El-Raghy, *J. Appl. Phys.*, 2000, **87**(4), 1701–1703.
- 12 D. T. Cuskelly, E. R. Richards, E. H. Kisi and V. J. Keast, *J. Solid State Chem.*, 2015, **230**, 418–425.
- 13 X. He, Y. Bai, Y. C. Zhou and M. W. Barsoum, *Acta Mater.*, 2011, **59**, 5523–5533.
- 14 X. He, Y. Bai, Y. C. Zhou, Y. Sun, M. Li and M. W. Barsoum, *Comput. Mater. Sci.*, 2010, **49**, 691–698.
- 15 G. Hug, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2006, **74**, 184113–184117.
- 16 J. Y. Wang and Y. C. Zhou, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2004, **69**, 144108–144113.
- 17 P. Eklund, J. P. Palmquist, J. H. wing, D. H. Trinh, T. El-Raghy, H. Hogberg and L. Hultman, *Acta Mater.*, 2007, **55**, 4723–4729.
- 18 M. W. Barsoum and M. Radovic, *Annu. Rev. Mater. Res.*, 2011, **41**, 195–227.
- 19 D. A. H. Hanaor, L. Hud, W. H. Kan, G. Proust, M. Foley, I. Karaman and M. Radovic, *Mater. Sci. Eng., A*, 2016, **672**, 247–256.
- 20 Y. Bai, N. Srikanth, C. K. Chua and K. Zhou, *Crit. Rev. Solid State Mater. Sci.*, 2017, **44**, 56–107.
- 21 J. P. Palmquist, S. Li, P. O. A. Persson, J. Emmerlich, O. Wilhelmsson, H. Högborg, M. I. Katsnelson, B. Johansson, R. Ahuja, O. Eriksson, L. Hultman and U. Jansson, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2004, **70**, 1–13.
- 22 M. Magnuson and M. Mattesini, *Thin Solid Films*, 2017, **621**, 108–130.
- 23 P. Eklund, M. Beckers, U. Jansson, H. Högborg and L. Hultman, *Thin Solid Films*, 2010, **518**, 1851–1878.
- 24 Y. C. Zhou, X. H. Wang, Z. M. Sun and S. Q. Chen, *J. Mater. Chem.*, 2001, **11**, 2235–2339.
- 25 T. E. Raghy and M. W. Barsoum, *J. Am. Ceram. Soc.*, 1999, **82**(10), 2849–2854.
- 26 T. Lapauwa, K. Lambrinoub, T. Cabioc, J. Halimd, J. Lud, A. Pesachf, O. Rivinf, O. Ozeri, E. N. Caspif, L. Hultmand, P. Eklund, J. Rosénd, M. W. Barsoum and J. Vleugels, *J. Eur. Ceram. Soc.*, 2016, **36**, 1847–1853.
- 27 J. Etzkorn, M. Ade and H. Hillebrecht, *Inorg. Chem.*, 2007, **46**, 7646–7653.
- 28 B. Anasori, M. Dahlqvist, J. Halim, E. J. Moon, j. Lu, B. C. Hosler, E. N. Caspi, S. J. May, L. Hultman, P. Eklund, J. Rosen and M. W. Barsoum, *J. Appl. Phys.*, 2015, **118**, 094304–094314.
- 29 A. Mockute, M. Dahlqvist, L. Hultman, P. O. A. Persson and J. Rosen, *J. Mater. Sci.*, 2013, **48**, 3686–3691.
- 30 Y. Xu, X. Bai, X. Zha, Q. Huang, J. He, K. Luo, Y. Zhou, T. C. Germann, J. S. Francisco and S. Du, *J. Chem. Phys.*, 2015, **143**, 114701–114707.
- 31 X. He, Y. Bai, Y. Li, C. Zhub and M. Li, *Solid State Commun.*, 2009, **149**, 564–566.
- 32 J. Huang, H. Wand, M. Lib, Y. Zang, J. Zaua, X. LI, W. Shui, Y. LI, X. Fan, Q. Wend, X. Xiaod and Q. Huang, *J. Adv. Ceram.*, 2021, **10**(5), 1–8.
- 33 K. Rajavel, X. Yu, P. Zhu, Y. Hu, R. Sun and C. Wong, *Langmuir*, 2014, **30**(2), 592–601.
- 34 S. Uzun, M. Han, C. J. Strobel, K. Hantanasirisakul, A. Goad, G. Dion and Y. Gogotsi, *Carbon*, 2021, **174**, 382–389.
- 35 M. Han, C. E. Shuck, R. Rakhmanov, D. Parchment, B. Anasori, C. M. Koo, G. Friedman and Y. Gogosti, *ACS Nano*, 2020, **14**, 5008–5016.
- 36 T. A. Prikhna, O. P. Ostash, A. S. Kuprin, V. Y. Podhurska, T. B. Serbenyuk, E. S. Gevorkyan, M. Rucki, W. Zurowski, W. Kucharczyk, V. B. Sverdun, M. V. Karpets, S. S. Ponomaryov, B. D. Vasylyv, V. E. Moshchil and M. A. Bortnitskaya, *Compos. Struct.*, 2021, **277**, 114649.
- 37 W. khon and L. J. sham, *Phys. Rev.*, 1965, **140**(4A), A1133–A1138.
- 38 S. J. Clark, M. D. Segall, C. J. Pickard, P. J. Hasnip, M. I. J. Probert, K. Refson and M. C. Payne, *Z. Kristallogr.*, 2005, **220**, 567–570.
- 39 N. Troullier and J. L. Martins, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1991, **43**, 1993–2006.
- 40 D. R. Hamann, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1989, **40**, 2980–2987.
- 41 H. J. Monkhorst and J. D. Pack, *Phys. Rev. B: Solid State*, 1976, **13**(12), 5188–5192.
- 42 T. H. Fischer and J. Almlöf, *J. Phys. Chem.*, 1992, **96**, 9768–9774.
- 43 R. P. Feynmann, Forces in Molecules, *Phys. Rev.*, 1939, **56**, 340–343.
- 44 J. P. Perdew and M. E. K. Burke, *J. Chem. Phys.*, 1996, **105**, 9982–9985.
- 45 H. Hsu, P. Blaha, M. Cococcioni and R. M. Wentzcovitch, *Phys. Rev. Lett.*, 2011, **106**, 118501–118504.
- 46 R. D. L. Kronig, *J. Opt. Soc. Am.*, 1926, **12**(6), 547–557.
- 47 K. Xiong, J. Robertson and S. J. Clark, *Appl. Phys. Lett.*, 2006, **89**, 022907.
- 48 D. Mainprice and M. Humbert, *Surv. Geophys.*, 1994, **15**, 575–592.



- 49 M. Hadi, M. Roknuzzaman, A. Chroneos, S. Naqib, A. Islam, R. Vovk and K. Ostrikov, *Comput. Mater. Sci.*, 2017, **137**, 318–326.
- 50 X. Gonze and C. Le, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1997, **55**, 10355–10368.
- 51 A. Candan, S. Akbudak, Ş. Uğurc and G. Uğurc, *J. Alloys Compd.*, 2019, **771**, 664–673.
- 52 M. W. Qureshi, X. Ma, G. Tang and R. Paudel, *Materials*, 2020, **13**, 5148.
- 53 M. Nadeem, M. Haseeb, A. Hussain, A. Javed, M. A. Rafiq, M. Ramzan, M. N. Rasul and M. Azhar Khan, *J. Mater. Res. Technol.*, 2021, **15**, 521–532.
- 54 M. T. Nasir, M. A. Hadi, S. H. Naqib and F. Parvin, *Int. J. Mod. Phys. B*, 2014, **28**(32), 1–16.
- 55 Y. Mo, P. Rulis and W. Y. Ching, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2012, **86**, 1–10.
- 56 M. S. Ali, M. A. Rayhan, M. A. Ali, R. Parvin and A. K. M. A. Islam, *J. Sci. Res.*, 2016, **8**(2), 109–117.
- 57 M. I. Hussain, R. M. A. Khalil, F. Hussain, M. Imran, A. M. Rana and S. Kim, *Mater. Sci. Semicond. Process.*, 2020, **113**, 105064–105069.
- 58 M. I. Hussain, R. M. A. Khalil, F. Hussain, A. M. Rana and M. Imran, *J. Mol. Graphics Modell.*, 2020, **99**, 1–11.
- 59 M. A. Hadi, M. Roknuzzaman, F. Parvin, S. H. Naqib, A. K. M. A. Islam and M. Aftabuzzaman, *J. Sci. Res.*, 2014, **6**(1), 11–27.
- 60 M. T. Nasir and A. K. M. A. Islam, *Comput. Mater. Sci.*, 2012, **65**, 365–371.
- 61 Y. Bai, X. He and R. Wang, *J. Raman Spectrosc.*, 2015, **46**(9), 784–794.
- 62 R. M. A. Khalil, F. Hussain, A. M. Rana, M. Imran and G. Murtaza, *Phys. E*, 2019, **106**, 338–345.
- 63 M. T. Nasir and A. K. M. A. Islam, *Comput. Mater. Sci.*, 2012, **65**, 365–371.
- 64 Y. Li, Y. Gao, B. Xiao, T. Mina, Y. Yanga, S. Maa and D. Yia, *J. Alloys Compd.*, 2011, **509**, 5242–5249.
- 65 M. Peng, R. Wang, Y. Wu, A. Yang and Y. Duan, *Vacuum*, 2021, 110715.
- 66 W. Voigt, *Lehrbuch der Kristallphysik*, B. G. Teubner, Leipzig, Berlin, 1928.
- 67 A. Reuss, *Z. Angew. Math. Mech.*, 1929, **9**, 49–58.
- 68 R. Hill, *Proc. Phys. Soc.*, 1952, **65**, 349354.
- 69 Z. Sun, D. Music, R. Ahuja and J. M. Schneider, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2005, **71**, 193402–193403.
- 70 X. Q. Chen, H. Niu, D. Li and Y. Li, *Intermetallic*, 2011, **19**, 1275–1281.
- 71 M. Roknuzzaman, M. A. Hadi, M. J. Abden, M. T. Nasir, A. K. M. A. Islam, M. S. Ali, K. Ostrikov and S. H. Naqib, *Comput. Mater. Sci.*, 2016, **113**, 148–153.
- 72 Y. Bai, X. Qi, A. Duff, N. Li, F. Kong, X. He, R. Wang and W. E. Lee, *Acta Mater.*, 2017, **132**, 69–81.
- 73 Y. Bai, X. Qi, X. He, D. Sun, F. Kong, Y. Zheng, R. Wang and A. L. Duff, *J. Am. Ceram. Soc.*, 2019, **102**, 3715–3727.
- 74 Y. Bai, X. He, Y. Sun, C. Zhu, M. Li and L. Shi, *Solid State Sci.*, 2010, **12**, 1220–1225.
- 75 L. F. He, Z. J. Lin, J. Y. Wang, Y. W. Bao, M. S. Li and Y. C. Zhou, Synthesis and characterization of bulk $Zr_2Al_3C_4$ ceramic, *J. Am. Ceram. Soc.*, 2007, **90**(11), 3687–3689.
- 76 R. M. A. Khalil, F. Hussain, M. I. Hussain, A. Parveen, M. Imran, G. Murtaza, M. A. Sattar, A. M. Rana and S. Kim, *J. Alloys Compd.*, 2020, **827**, 154255–154257.

